



IM - B Relay

- Minimum board-space 60mm²
- Slim line 10x6mm (0.39x0.24") and low profile 5.65mm (0.222")
- Switching power 60W/62.5VA
- Switching voltage 220VDC/250VAC
- Switching current 2A
- **■** Bifurcated contacts
- High mechanical shock resistance

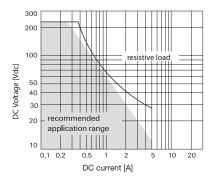
Typical applications

Telecommunication, access and transmission equipment, optical network terminals, modems, office and business equipment, consumer electronics, measurement and Test equipment, industrial control, medical equipment, automotive applications



Contact Data	
Contact arrangement	1 form A (1 NO)
Max. switching voltage	220VDC, 250VAC
Rated current	2A
Limiting continuous current	2A
Switching power	60W, 62.5VA
Contact material	PdRu
	Au covered
Contact style	twin contacts
Minimum switching voltage	100µV
Initial contact resistance	<100mΩ at 10mA/30mV
Thermoelectric potential	<10µV
Operate time	typ. 1ms, max. 3ms
Release time	
without diode in parallel	typ. 1ms, max. 3ms
with diode in parallel	typ. 3ms, max. 5ms
Bounce time max.	typ. 1ms, max. 5ms
Electrical endurance	
at contact application 0	
(≤ 30mV / ≤ 10mA)	min. 2.5x10 ⁶ operations
cable load open end	min. 2.0x10 ⁶ operations
resistive, 125VDC / 0.24A - 30W	min. 5x10 ⁵ operations
resistive, 220 VDC / 0.27A - 60W	min. 1x10 ⁵ operations
resistive, 250VAC / 0.25A - 62.5VA	min. 1x10 ⁵ operations
resistive, 30VDC / 1A - 30W	min. 5x10 ⁵ operations
resistive, 30VDC / 2A - 60W	min. 1x10 ⁵ operations

Max. DC load breaking capacity





Al

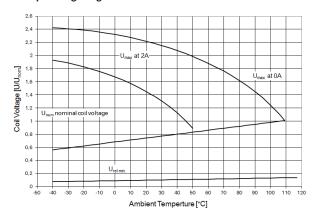
Coil Data	
Magnetic system	monostable, bistable
Coil voltage range	1.5 to 24VDC
Max. coil temperature	125°C
Thermal resistance	<150K/W

Coil versions, standard version, monostable, 1 coil Rated coil Rated Release Coil Operate Coil voltage voltage code resistance voltage power **VDC VDC VDC** $\Omega \pm 10\%$ mW

01 3.0 2.25 0.30 140 02 4.5 3.38 0.45 145 140 03 3.75 178 140 5.0 0.50 06 12.0 9.00 1.20 1029 140

All figures are given for coil without pre-energization, at ambient temperature +23°C

Coil operating range





AXICOM



IM - B Relay (Continued)

Insulation C				
	high dielectric version			
Initial dielectric strength				
between open contacts	2500Vrms			
between contact and coil	3500Vrms			
Initial surge withstand voltage				
between open contacts	3500V			
between contact and coil	4900V			
Initial insulation resistance				
between insulated elements	>10 ⁹ Ω			
Capacitance				
between open contacts	max. 1pF			
between contact and coil	max. 2pF			
between adjacent contacts	max. 2pF			

RF Data	
Isolation at 100MHz/900MHz	37.0dB/18.8dB
Insertion loss at 100MHz/900MHz	0.03dB/0.33dB
Voltage standing wave ratio (VSWR)	
at 100MHz/900MHz	1.06/1.49

Other Data

Material compliance: EU RoHS/ELV, China RoHS, REACH, Halogen content refer to the Product Compliance Support Center at www.te.com/customersupport/rohssupportcenter

Ambient temperature -40°C to +85°C < 150K/W Thermal resistance

Category of environmental protection

IEC 61810 RT V - hermetically sealed

Degree of protection

IEC 60529 IP 67, immersion cleanable Vibration resistance (functional) 20g, 10 to 500Hz Shock resistance (functional), half sinus 11ms 50g 500g Shock resistance (destructive), half sinus 0.5ms Weight max. 0.75g Resistance to soldering heat THT

IEC 60068-2-20 265°C/10s

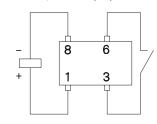
Resistance to soldering heat SMT

IEC 60068-2-58 265°C/10s Moisture sensitive level, JEDEC J-Std-020D MSL3 Ultrasonic cleaning not recommended

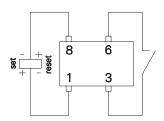
Packaging/unit THT version tube/50pcs., box/1000 pcs. SMT version reel/1000 pcs., box/1000 or 5000 pcs. Terminal assignment

TOP view on relay

IM-B, 1 form A (NO)

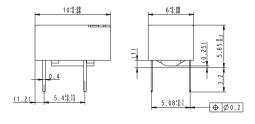


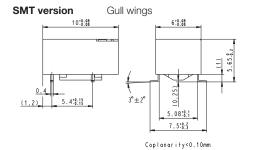
Contacts are shown in reset condition. Contact position might change during transportation and must be reset before use.



Dimensions

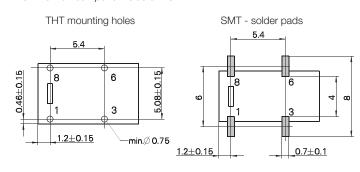
THT version Standard version

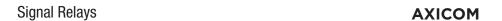




PCB layout

TOP view on component side of PCB



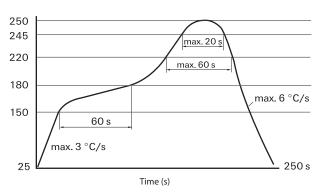


RELAY PRODUCTS

IM - B Relay (Continued)

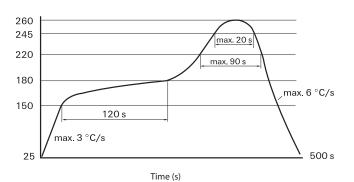
Processing Recommended soldering conditions

Soldering conditions according IEC 60058-2-58 and IPC/JEDEC J-STD-020D

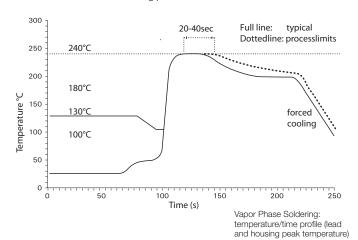


Resistance to soldering heat - Reflow profile

Infrared Soldering: temperature/ time profile (lead and housing peak temperature)

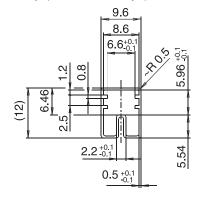


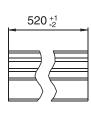
Recommended reflow soldering profile



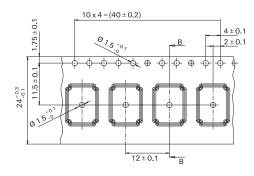
Packing

Tube for THT version
50 relays per tube, 1000 relays per box



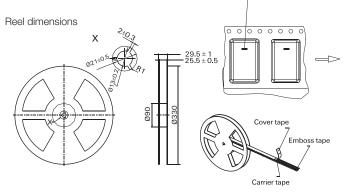


Tape and reel for SMT version 1000 relays per reel, 1000 or 5000 relays per box





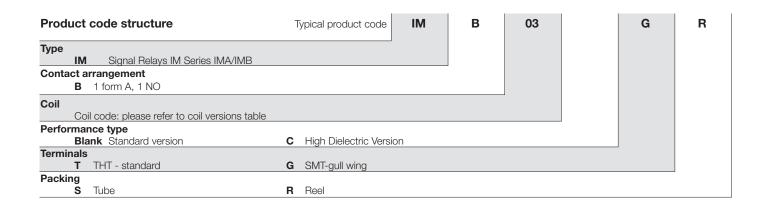
Orientation mark





Signal Relays AXICOM

IM - B Relay (Continued)



Product code	Arrangement	Perf. type	Coil	Coil type	Terminals	Part number
IMB01CGR	1 form A,	High dielectric	3VDC	Monostable	SMT gull wing	1462041-1
IMB01CTS	1 NO				THT standard	1462041-4
IMB02CGR	contact		4.5VDC		SMT gull wing	1462041-2
IMB02CTS					THT standard	1462041-5
IMB03CGR			5VDC		SMT gull wing	1462041-7
IMB03CTS					THT standard	1462041-8
IMB04CGR			6VDC		SMT gull wing	1462041-9
IMB06CGR			12VDC			1462041-3
IMB06CTS					THT standard	1462041-6
IMB07CGR			24VDC		SMT gull wing	1-1462041-3
IMB07CTS					THT standard	1-1462041-4
IMB42CGR			4.5VDC	Bistable	SMT gull wing	1-1462041-6
IMB42CTS					THT standard	1-1462041-5